

4 Pad Ceramic Package Quartz Crystal, 2.0mm x 1.6mm



Product Features:

AEC – Q200 qualified TS16949 certified production lines RoHS and REACH compliant Suitable for use in harsh environments Extended operating temperature range: -40°C to +125°C

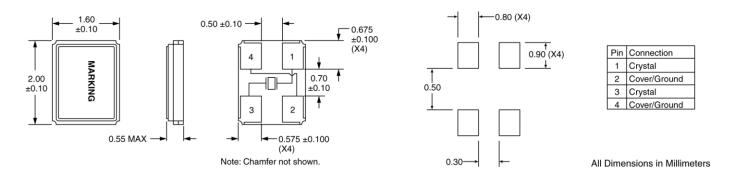
Applications:

Navigation, GPS Infotainment System Instrument Panel, Ethernet ADAS Radar, Camera, Engine Control Units Lidar Systems, TPMS

Electrical Specifications

Frequency	16MHz to 54MHz	
Equivalent Series Resistance		
16MHz – 20.999999MHz	200 Ohms Maximum	
20MHz – 25.999999MHz	120 Ohms Maximum	
25MHz – 39.999999MHz	100 Ohms Maximum	
40MHz – 54MHz	60 Ohms Maximum	
Shunt Capacitance (C0)	3pF Maximum	
Frequency Tolerance (at 25°C)	±50ppm, ±30ppm, ±25ppm, ±20ppm, ±15ppm, or ±10ppm	
Frequency Stability (over Temperature)	±100ppm, ±50ppm, ±30ppm, or ±20ppm	
Mode of Operation	Fundamental	
Crystal Cut	AT Cut	
Load Capacitance	8pF to 32pF or Specify	
Drive Level	100μW Maximum	
Aging	±3ppm/Year Maximum	
Operating Temperature Range	-40°C to +85°C, -40°C to +105°C, or -40°C to +125°C	
Storage Temperature Range	-50°C to +150°C	

Mechanical and Solder Pad Dimensions



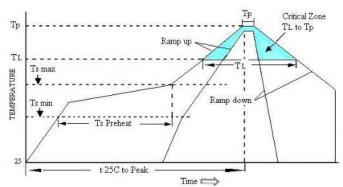
Part Number Guide

	Sample Part Number: IXA12 - FBDF18 - 20.000 MHz						
Package	Frequency Tolerance	Frequency Stability	Operating Temperature Range	Mode of Operations	Load Capacitance	Frequency	
	B = ±50ppm	A = ±100ppm	5 = -40°C to +85°C	F = Fundamental		- 20.000 MHz	
	F = ±30ppm	$B = \pm 50$ ppm	D = -40°C to +105°C		8pF to 32pF or Specify		
IXA12 -	G = ±25ppm	F = ±30ppm*, **	F = -40°C to +125°C				
	H = ±20ppm	H = ±20ppm*, **					
	I = ±15ppm						
	J = ±10ppm						

^{*} Not available at all frequencies. ** Not available for all temperature ranges.



Pb Free Solder Reflow Profile:



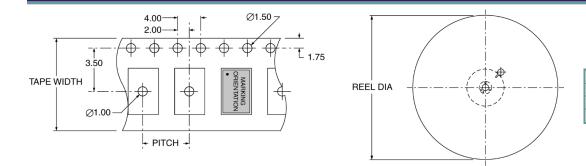
Units are backward compatible with +240°C reflow processes

Ts max to T _L (Ramp-up Rate)	3°C / second max
Preheat	
Temperature min (Ts min)	150°C
Temperature typ (Ts typ)	175°C
Temperature max (Ts max)	200°C
Time (Ts)	60 to180 seconds
Ramp-up Tate (T _L to Tp	3°C / second max
Time Maintained Above	
Temperature (T _L)	217ºC
Time (T _{L)}	60 to 150 seconds
Peak Temperature (Tp)	260°C max for 10
	seconds
Time within 5°C to Peak	20 to 40 seconds
Temperature (Tp)	20 to 40 seconds
Ramp-down Rate	6°C / second max
Tune 25°C to Peak Temperature	8 minutes max

Package Information:

MSL = 1 (package does not contain plastic, storage life is unlimited under normal room conditions) Termination = e4 (Au over Ni over W base metallization)

Tape and Reel Information:



PITCH	4.00
TAPE WIDTH	8.00
REEL DIA	180
QTY PER REEL	3,000

Environmental Specifications:

Mechanical Shock	MIL-STD-202, Method 213
Vibration	MIL-STD-202, Method 204
Resistance to Soldering Heat	MIL-STD-202, Method 210
Solderability	J-STD-002
Gross Leak	MIL-STD-883, Method 1014, Condition C
Fine Leak	MIL-STD-883, Method 1014, Condition A2

Marking:

Line 1: Frequency (XX.XX) Line 2: Date Code (YWW)